

APE | Asia
Photonics
Expo

4 - 6 February 2026
Sands Expo and Convention Centre, Singapore

Held in:



Brought to you by:



Supported by:



PRESHOW GUIDE 2026

Updated as of 7 Jan 2026

*Driving Innovation Where
Photonics Meets Semiconductors*



REGISTER FOR
YOUR FREE PASS



JOIN APE'S WHATSAPP
COMMUNITY

#APE2026     

www.asiaphotonicsexpo.com



Table of Contents

2026 Highlights	3
Exhibit Profile	4
National and Regional Pavilions	5 - 6
Featured Zones	
- Quantum Photonics x Semiconductor Innovation Laser and Laser Equipment Optical Component/Lens Vacuum Coating Infrared Night Vision Device	7 - 8
Featured Product Spotlight	
- Semiconductor Equipment - Die Bonder/Lithography Machine/UV LED Curing Machine/Dicing Saw/Scribing Machine/Dispensing Machine and Core Parts	
- Semiconductor Material Semiconductor Fabrication and Packaging Service	
- Quantum Measurement/Quantum Communication	
- Optical Communication Chip and Material Optical Communication Module Optical Communication Device Optical Communication Transmission Equipment	
- Optical Fiber Cable and Wire Wiring Product Cable Manufacturing Equipment	
- Optical Component – Lens/Micro Lens/Metalens/Filter/Optical Design Software Medical/AR&VR/Automotive Optics Camera Lens Optics Fabrication and Design Software	
- Optical Processing Equipment Optical Coating Equipment	
- Laser Laser Component Laser Equipment Infrared Optics and Lens Infrared Device LiDAR and Sensing	
- Optical Test and Measurement Test and Measurement - Alignment Equipment/Spectroscopy/Microscope/Imaging Measurement/AOI/Positioning System	9 - 29
Concurrent Conferences	30 - 41
Networking Events	42 - 45
APE 2026 Featured Visitor Registration List	46
Delegation & VIP Buyer (Business Matchmaking)	47
Traffic Guide & Hotel Reservation	48 - 49
Brochures Download	50



Asia Photonics Expo (APE), as Asia's leading platform for photonics innovation, showcases cutting-edge technologies across **optical communications, optics, semiconductors, lasers, infrared, sensing, quantum**, and more. APE 2026 will highlight **6 featured zones** and **9 national and regional pavilions** representing global technological advancement while deepening synergy between the photonics and semiconductor sectors. Alongside a variety of **networking programmes**, it enables the industry professionals to forge new partnerships, unlock market insights, and drive collaborative growth.

2026 HIGHLIGHTS

Photonics & Semiconductor Advancements

- Bridging photonics and semiconductors to drive innovation and integration
- Covering the full spectrum from materials, design, manufacturing, packaging, and testing
- Showcasing silicon photonic chips, photonic integrated circuits (PICs), semiconductor fabrication, and packaging equipment
- Leveraging the synergy to advance technology and enable cross-industry collaboration

9 National and Regional Pavilions

- China
- Europe
- Germany
- Japan
- Malaysia
- Singapore
- South Korea
- Taiwan
- USA

6 Featured Zones

- Infrared Night Vision Device
- Optical Component/Lens
- Laser and Laser Equipment
- Quantum
- Photonics x Semiconductor Innovation
- Vacuum Coating

Networking Opportunities

- Business Matchmaking
- Happy Hour
- Gala Dinner (By Invitation Only)
- Site Tour
 - 1) JM VisTec & MMI Systems
 - 2) LITEON & SUTD
 - 3) NTU & A*STAR NSTIC

Concurrent Conferences

- Quantum Singapore
- Photonics@SG (LUX Photonics Consortium)
- Asia Semiconductor Conference (SSIA)
- EPIC TechWatch
- EUROPE meets ASIA
- Advanced Semiconductor Manufacturing
- Machine Vision Enabling Industrial Intelligent Manufacturing
- Asia Photonics Conference



Exhibit Profile

Optical Communication

- Optical Communication Chip
- Optical Communication Module and Device
- Wireless Communication
- Optical Communication Transmission Equipment
- Instrument
- Optical Fiber Cable / Fiber Sensing
- Semiconductor Material
- Semiconductor Equipment and Manufacturing

Sensing

- Industrial Sensor
- 3D Vision and Imaging
- LiDAR
- Testing and Measuring Instrument

Optics

- Optical Material
- Optical Component
- Optical Lens and Module
- Optical Processing Equipment
- Machine Vision Product
- Optical Measuring Instrument

Quantum

- Quantum Communication
- Quantum Computing
- Quantum Measurement

Infrared

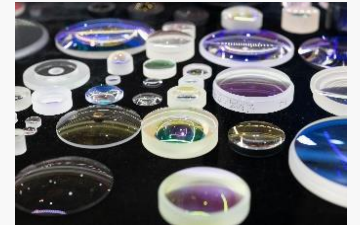
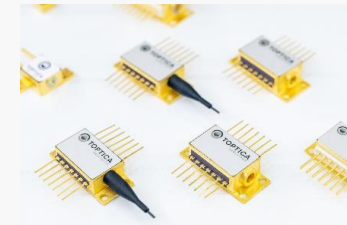
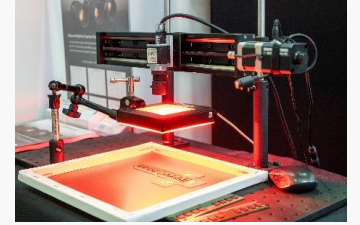
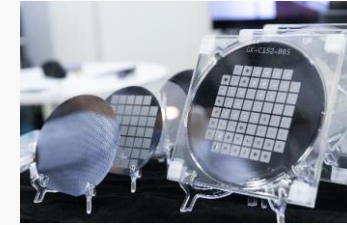
- Thermal Imager
- Night Vision Device
- Infrared Material and Component
- Infrared Detector

Semiconductor

- Design / EDA / IP
- Semiconductor Material
- Semiconductor Core Part
- Wafer Fabrication Equipment
- Assembly & Packaging Equipment
- Test and Inspection Equipment
- Foundry
- Outsourced Semiconductor Assembly and Test (OSAT)
- Integrated Circuit Chip

Laser

- Lasers
- Laser Equipment
- Laser Material and Component
- Robot and Industrial Automation
- 3D Printing / Additive Manufacturing





Featured Companies Within National and Regional Pavilions

SINGAPORE/MALAYSIA

- ACEXON TECHNOLOGIES
 - ADVINNO TECHNOLOGIES
 - AIRBOARD TECHNOLOGY
 - APP SYSTEMS SERVICES
 - BOTE OPTICS
 - CPG OPTICS
 - DOU YEE ENTERPRISES
 - DSC INDUSTRIAL
 - EPOXY AND EQUIPMENT TECHNOLOGY
 - HAKUTO SINGAPORE
 - HITRONICS TECHNOLOGIES MALAYSIA
 - JD UNION
 - MOVEON TECHNOLOGIES
 - NEXUSTEST
 - OPTICAL GAGING
 - OPTO PRECISION
 - SINGAPORE PRECISION ENGINEERING AND TECHNOLOGY ASSOCIATION
 - PRECISION TECHNOLOGIES
 - SD OPTICS SINGAPORE
 - WAVELENGTH OPTO-ELECTRONIC
- and many more...*

EUROPE

- CHROMA TECHNOLOGY
 - EPIC
 - HELLMA MATERIALS
 - IMT Masken und Teilungen
 - IVAM MICROTECHNOLOGY NETWORK
 - LAMBDA GLASS SOLUTIONS
 - LEJ - LEISTUNGSELEKTRONIK JENA
 - MÄRZHÄUSER WETZLAR
 - SATISLOH
 - TECNOTTICA CONSONNI
 - TNO
 - UAB ALTECHNA
 - W3 + FAIR - FLEET EVENT
- and many more...*

GERMANY

- ASSOCIATION FOR THE GERMAN TRADE FAIR INDUSTRY (AUMA)
 - ASPHERICON
 - AVENIR PHOTONICS
 - CRYLAS
 - FEDERAL MINISTRY FOR ECONOMIC AFFAIRS AND ENERGY (BMWE)
 - INSTRUMENT SYSTEMS
 - MÖLLER-WEDEL OPTICAL
 - OPTOTECH OPTIKMASCHINEN
 - PICOLAS
 - QUBIG
 - RAYLASE
 - SCANLAB
 - SMARACT
 - SPECTARIS
- and many more...*

* Exhibitors are listed in alphabetical order



Featured Companies Within National and Regional Pavilions

CHINA

- ADVANCED FIBER RESOURCES
 - APEX OPTICS
 - BLUE RESOURCE OPTICS
 - BOHONGYUAN EQUIPMENT
 - BOXIN PHOTOELECTRIC
 - DIMENSION TECHNOLOGY
 - ETERN
 - FLYIN GROUP
 - GIAI PHOTONICS
 - HENG TONG OPTIC-ELECTRIC
 - HITRONICS TECHNOLOGIES
 - IN-CUBE AUTOMATION
 - JUCHENG
 - KAIXIN OPTICAL&ELETRONIC
 - LBD TECHNOLOGY
 - LIEQI INTELLIGENT EQUIPMENT
 - MICROVIEW INTELLIGENT PACKAGING TECHNOLOGY
 - OUGUANG
 - T&S COMMUNICATIONS
 - THAHOO PHOTOELECTRIC
 - TONGGUANG OPTICAL FIBER CABLE
 - TRIPLE-STONE TECHNOLOGY
 - ULVAC
 - UM OPTICS
 - VIKO OPTOELECTRONICS
- and many more...*

JAPAN/KOREA

- ADVANCED THERMAL TECHNOLOGY
 - AGC ASIA PACIFIC
 - DISCO HI-TEC (SINGAPORE)
 - FERROTEC SEMICODUTOR TECHNOLOGY
 - KOREA ADVANCED MATERIALS
 - MICROVITA-INSTRUMENT
 - MITUTOYO ASIA PACIFIC
 - PANASONIC FACTORY SOLUTIONS ASIA PACIFIC
 - PHOTONTECK
 - PIEZOELECTRIC TECHNOLOGY
 - WOORIRO
- and many more...*

TAIWAN

- GIE OPTICS
 - HRLASER
 - UNION OPTRONICS
- and many more...*

USA

- ARCHER OPTX
 - AMETEK
 - FILTCOMM TECHNOLOGY
 - MRSI AUTOMATION
- and many more...*

* Exhibitors are listed in alphabetical order



Featured Zones

The **6 Featured Zones** on the APE exhibition show floor are strategically designed for highly targeted sourcing of products and services across key sectors, ensuring a focused and efficient experience for attendees.

Quantum Zone

The Quantum Zone showcases cutting-edge technologies and products in **quantum computing, quantum communication & security, quantum measurement**, and core upstream components. The focus will extend to its practical applications in critical sectors such as communications, biomedical sensing, advanced testing and measurement, and next-generation AI systems.

Exhibitors include:

- FIBER-CUBE
- SNP PRECISION OPTICS
- WESTERN SUPERCONDUCTING TECHNOLOGIES
- XINNAN ZHIKE

Photonics × Semiconductor Innovation Zone

Spanning the integrated ecosystems of photonics and semiconductors, this zone will showcase key breakthroughs in **IC design, compound semiconductors, wafer-level manufacturing, advanced lithography, and system-in-package solutions**. Tailored for suppliers, solution providers and end-users, it will facilitate connections, insights sharing and partnership-building across the value chain.

Exhibitors include:

- | | |
|-----------------------------------|---------------------------|
| • CORNING INTERNATIONAL SINGAPORE | • PBA SYSTEMS |
| • COSMOS INNOVATION | • SENSILITE TECHNOLOGY |
| • METAOPTICS TECHNOLOGIES | • SOITEC MICROELECTRONICS |
| • NICSLAB OPS | • SPOTICS |
| • NSC INNOVATION | • SUNYU PHOTONICS |

Laser and Laser Equipment Zone

From **laser marker and welder** for electronics manufacturing and **laser cleaner** for industrial maintenance, and **laser cutting machine** for semiconductor manufacturing—this zone gathers versatile laser solutions that drive efficiency and innovation in industrial and daily operations.

Exhibitors include:

- CENTRAL RISE
- CRYSTRONG PHOTONICS
- GWEIKE TECH
- GYOPTICS TECHNOLOGY
- HRLASER
- STRONG LASER ADVANCED EQUIPMENT
- XK PHOTONICS
- YOEC-SPECIALTY FIBER



Featured Zones

The **6 Featured Zones** on the APE exhibition show floor are strategically designed for highly targeted sourcing of products and services across key sectors, ensuring a focused and efficient experience for attendees.

Optical Component/Lens Zone

The optical component and lens serve as the backbone of photonics and semiconductor ecosystems. From **filters, prisms to lenses**, and **integrated optical modules**, this zone gathers industry-leading innovations that power critical applications spanning **optical communication, quantum computing, industrial sensing, medical** and **semiconductor manufacturing**.

Exhibitors include:

- BLUE RESOURCE OPTICS
- BOXIN PHOTOELECTRIC
- KEYENCE
- LANTE OPTICS
- TRACE OPTICAL

Vacuum Coating Zone

Vacuum coating technology is a key enabler for a wide range of applications, including **semiconductors, optics, electronics, and materials**. Displaying vacuum coating technology at APE 2026 provides the opportunity for attendees to learn about the latest techniques and applications in the field.

Exhibitors include:

- BUHLER ASIA
- CNS VISION TECHNOLOGY
- ELEMENT VACUUM TECHNOLOGY
- HUICHENG
- KURT LESKER
- SISHENG TECHNOLOGY
- ULVAC

Infrared Night Vision Device Zone

The Infrared Night Vision Device Zone emerges as a high-focus highlight across the global market. As demand surges in the fields of **security & surveillance, defense, ocean, Petroleum and Petrochemical, and industrial inspection**—this zone converges cutting-edge **infrared detectors, thermal imaging devices, night vision scopes and hyperspectral camera** from top industry players.

Exhibitors include:

- BAITENG ELECTRONIC TECHNOLOGY
- CORENT
- CHINA STATE SHIPBUILDING HONGYANG
- DOSPECTRUM
- SHIYUTONG TECHNOLOGY
- VITAL OPTICS TECHNOLOGY



Featured Product Spotlight

Semiconductor Equipment - Die Bonder

MRSI AUTOMATION
BOOTH NO.: B214



MRSI-H1 Family 1-MICRON Flip-chip Die Bonder

BOZHON
SEMICONDUCTOR
BOOTH NO.: A504



MicroStar Series EF8622 Eutectic Die Bonding Machine

LASER X TECHNOLOGY
BOOTH NO.: A808-17



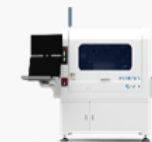
Automatic High Precision Die Bonder

MICROVIEW INTELLIGENT
PACKAGING TECHNOLOGY
BOOTH NO.: B101



1.5µm High-speed Bonder Mbonder-HGM

LIEQI INTELLIGENT
EQUIPMENT
BOOTH NO.: A314



HS-DB3000 Multi-Chip Die Bonder

AIT PRECISION
TECHNOLOGY
BOOTH NO.: A113



Die Bonder

**Exhibitors are listed in no order.*

Semiconductor Equipment - Lithography Machine/UV LED Curing Machine

TIMEMAKER
CRYSTAL TECHNOLOGY
BOOTH NO.: A203



Lithography Machine

IBRNTECH
BOOTH NO.: D301



Lithographic Exposure

IBRNTECH
BOOTH NO.: D301



UVLED Curing

EPOXY AND EQUIPMENT
TECHNOLOGY
BOOTH NO.: B511



Technodigm LED UV Curing Systems

DOU YEE ENTERPRISES (S)
BOOTH NO.: B512



Hoya UV LED Technology

[>>> View More Products](#)



Featured Product Spotlight

Semiconductor Equipment – Dicing Saw/Scribing Machine/Dispensing Machine

*Exhibitors are listed in no order.

DISCO HI-TEC (SINGAPORE)
BOOTH NO.: A332



DFL7362 Fully
Automatic Laser Saw

DISCO HI-TEC (SINGAPORE)
BOOTH NO.: A332



DFD6363 Fully Automatic
Dicing Saw

THAHOO PHOTOELECTRIC
TECHNOLOGY
BOOTH NO.: B106



Compound Semiconductor
Chip Scribing/Splitting
Machine

DOU YEE ENTERPRISES (S)
BOOTH NO.: B512



FAD5100WH -
Dispensing Machine

IN-CUBE AUTOMATION
BOOTH NO.: B111



LD Bar Stacking
Machine

SINGPHOTONICS
INTERNATIONAL
BOOTH NO.: A222



Fully Automated Photonic
Integration of Hybrid
Multi-chip Assemblies

Semiconductor Equipment – Core Parts

DOU YEE ENTERPRISES (S)
BOOTH NO.: B512



HyperJet2 - Jetting Valve

AKRIBIS SYSTEMS
BOOTH NO.: A513, A512



Servo Motor And Driver

PICOLAS GMBH
BOOTH NO.: A134



LDP-CWM 300 - High
Power cw- and qcw Driver

MICRO MOTION TECHNOLOGY
BOOTH NO.: D124



Absolute Encoder &
Stepper Motor Driver

PIEZOELECTRIC TECHNOLOGY
BOOTH NO.: B104



Auto Focus Module

THANS VIBRATION
ISOLATION TECHNOLOGY
BOOTH NO.: C124



THS3 Advanced
Vibration Isolator

[>>> View More Products](#)



Featured Product Spotlight

Semiconductor Material

*Exhibitors are listed in no order.

NOVEL SI INTEGRATION
TECHNOLOGY
BOOTH NO.: A201



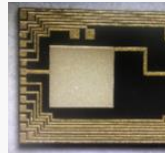
4/6/8-inch TFLT

HELLMA MATERIALS
BOOTH NO.: C208



Calcium Fluoride

COREWAY OPTECH
BOOTH NO.: A532



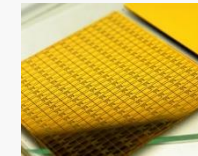
Series D - AuSn Solder
Integrated

JINGZHENG
ELECTRONICS BOOTH
NO.: A005



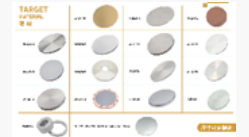
Lithium Niobate Thin Films

HOTLONG
BOOTH NO.: D203



Heatsink

ZI JIN INNOVATION
APPLIED MATERIALS
BOOTH NO.: C222



Target Material

Semiconductor Fabrication and Packaging Service

OPTO PRECISION
BOOTH NO.: B533



Microfabrication and
Packaging Solutions

DISCO HI-TEC (SINGAPORE)
BOOTH NO.: A332



KKM Service

LAMBDA GLASS SOLUTIONS
BOOTH NO.: C206



Packaging Solutions in
Quartz Glass

FIC GLOBAL
BOOTH NO.: A521



Advanced Optical
Packaging & Integrated
Manufacturing

[>>> View More Products](#)



Featured Product Spotlight

Quantum Measurement/Quantum Communication

ACEXON TECHNOLOGIES
BOOTH NO.: B311



TOPTICLOCK - Optical
Quantum Clock

OPTOSIGMA
SOUTHEAST ASIA
BOOTH NO.: B301



Quantum Technology

DOSPECTRUM
BOOTH NO.: C113



Quantum Cascade
Laser

QUBIG GMBH
BOOTH NO.: A221



Single-Photon Demultiplexing
Systems (DMX)

TNO SCIENCE AND
INDUSTRY
BOOTH NO.: C204



Quantum SatCom

XINNAN ZHIKE
OPTOELECTRONIC TECHNOLOGY
BOOTH NO.: C304



High-Precision UHV
Polyhedral Glass Cells

**Exhibitors are listed in no order.*

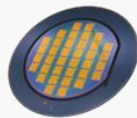
Optical Communication Chip and Material

WOORIRO
BOOTH NO.: B103



CWDM Chip

ANPI OPTOELECTRONICS
BOOTH NO.: A006



Thin Film Lithium Niobate
Modulator Chips

ADVANCED THERMAL
TECHNOLOGY
BOOTH NO.: A321



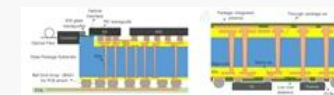
TEC

FERROTEC SEMICONDUCTOR
TECHNOLOGY
BOOTH NO.: A322



DPC Copper Plated
Ceramic Substrates

SENWAN ELECTRONIC
TECHNOLOGY
BOOTH NO.: C321, C322



TGV Through Glass Via
Substrate

WANHUA
BOOTH NO.: D202



Rough Polishing Pad

[>>> View More Products](#)



Featured Product Spotlight

Optical Communication Module

*Exhibitors are listed in no order.

VISINT COMMUNICATION
TECHNOLOGY
BOOTH NO.: A104



Optical Transceiver

T&S COMMUNICATIONS
BOOTH NO.: B202, B201



800G QSFP-DD Fiber
Optic Transceiver

FLYIN GROUP
BOOTH NO.: A213, A214



Optical Transceiver

HENGTONG OPTIC-ELECTRIC
BOOTH NO.: A311, A312



Optical Module

FLC GLOBAL
BOOTH NO.: A521



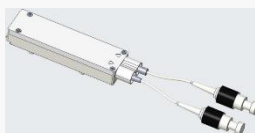
High-Speed Optical
Transceiver PCBA &
Turnkey Manufacturing

FLC GLOBAL
BOOTH NO.: A521



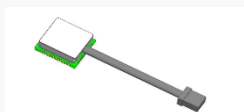
Next-Generation
Optical Transceiver
JDM Co-Design

HIIC-TECH(QINGDAO)
MICROELECTRONICS
BOOTH NO.: A808-7



DWDM Optical Module

HIIC-TECH(QINGDAO)
MICROELECTRONICS
BOOTH NO.: A808-7



LCC Optical Module

LIANWANG RUIJIE
COMMUNICATION TECHNOLOGY
BOOTH NO.: A808-5



SFP Optical Modules

QUBIG GMBH
BOOTH NO.: A221



Broadband Phase
Modulators (TWP)

WAVELENGTH OPTO-
ELECTRONIC (S)
BOOTH NO.: B514



Optical Modulators

KOREA ADVANCED
MATERIALS
BOOTH NO.: B102



AWG Module

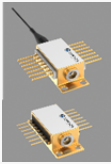
[>>> View More Products](#)



Featured Product Spotlight

Optical Communication Device – Active Device

PRECISION TECHNOLOGIES
BOOTH NO.: B323



Optica Eagleyard miniTA, miniECL, DFB Laser Diodes, Tapered Amplifiers, Multimode Laser Diodes, Gain Chips

WOORIRO
BOOTH NO.: B103



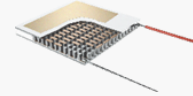
SPAD (Single-Photon Avalanche Diode)

BELY INFORMATION
TECHNOLOGY
BOOTH NO.: A634



Laser diode/Photodiode/BOSA

ADVANCED THERMAL
TECHNOLOGY
BOOTH NO.: A321



Thermoelectric Modules

YOEC-SPECIALTY FIBER
BOOTH NO.: D212



Optical Module for FOG

ANPI OPTOELECTRONICS
BOOTH NO.: A006



Thin Film Lithium Niobate IQ Modulator

*Exhibitors are listed in no order.

Optical Communication Device – Passive Device

EDMUND OPTICS
SINGAPORE
BOOTH NO.: B303



Waveplates

LAMBDA GLASS
SOLUTIONS
BOOTH NO.: C206



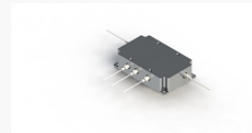
3D Quartz Glass Fiber Ferrules

BEECON CONNECTIVITY
BOOTH NO.: A012



16F MPO Ferrule

PHOTONTECK
BOOTH NO.: B112, B113



High Extinction Ratio Polarization-Maintaining Fiber Splitter

SUNET TECHNOLOGIES
BOOTH NO.: A601



PLC Splitter

CHAIN STEV INDUSTRY
BOOTH NO.: A501



Fiber PLC Splitter

>>> [View More Products](#)

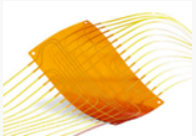


Featured Product Spotlight

Optical Communication Device – Passive Device

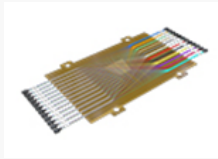
*Exhibitors are listed in no order.

T&S COMMUNICATIONS
BOOTH NO.: B202, B201



Fiber Optic Flex Circuit
(FOFC)

ADTEK TECHNOLOGY
BOOTH NO.: A111



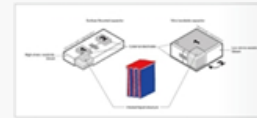
Adtek Optical Fiber
Flex Circuit

BEIJINGAUMIWALKER
BOOTH NO.: A808-10



Bias-Tee

SENWAN ELECTRONIC
TECHNOLOGY
BOOTH NO.: C321, C322



Silicon Capacitor

VIKO OPTOELECTRONICS
TECHNOLOGY
BOOTH NO.: A621



Transceiver TFF
Integrated Optical
Component

GMF TELECOM
BOOTH NO.: A805



Micro Duct Connector
and Cap

HUAXING ELECTRONIC
NETWORK
BOOTH NO.: A624



Fiber Optic Quick
Connector

BOXIANG OPTICAL
COMMUNICATION EQUIPMENT
BOOTH NO.: A612



Optoelectronic Hybrid
Connector

TUOLIMA
BOOTH NO.: A808-3



3-in-1 IP68 Waterproof
Connector

JITONG ELECTRONICS
BOOTH NO.: A807



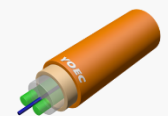
Fast Connector

LITAS OPTICAL
TECHNOLOGIES
BOOTH NO.: A808-20



Non-Contact MPO Fiber
Connector

YOEC-SPECIALTY FIBER
BOOTH NO.: D212



Panda Polarization-
maintaining Fiber

[>>> View More Products](#)



Featured Product Spotlight

Optical Communication Transmission Equipment

*Exhibitors are listed in no order.

ISEELINK COMMUNICATION
BOOTH NO.: A115



OSP3800 CWDM/DWDM
Wavelength Division
Transmission Equipment

VISINT
COMMUNICATION
BOOTH NO.: A104



Vispace1000 DCI BOX

FLYIN GROUP
BOOTH NO.: A213, A214



WDM

LUCENTFIBER
BOOTH NO.: A808-2



FWDM / CWDM /
DWDM MUX DEMUX

ZIKUN INFORMATION
TECHNOLOGY
BOOTH NO.: A622



ZC-521X6D(ONU)

CEITA COMMUNICATIONS
BOOTH NO.: A806



AX3000 Router 2.5GE
WAN+4GE LAN+AX3000
WiFi6 +Mesh R5

Optical Fiber Cable and Wire

TONGXIN OPTICAL
COMMUNICATION
BOOTH NO.: A116



MPO/MTP Fanout
Patch Cord

CYS COMMUNICATION
BOOTH NO.: A202



Optical Patchcords With
MPO Push-pull Boot
Connectors

YRT COMMUNICATIONS
BOOTH NO.: A631, A632



Fiber Optical Patch Cords

WESTERN SUPERCONDUCTING
TECHNOLOGIES
BOOTH NO.: C305



Superconducting
Coaxial Cable

C-FLINK TECHNOLOGY
BOOTH NO.: A103



1.6T OSFP224 ACC

XINMAI OPTOELECTRONICS
TECHNOLOGY
BOOTH NO.: A801



GYFTZY

[>>> View More Products](#)



Featured Product Spotlight

Wiring Product

*Exhibitors are listed in no order.

YOOHON TECHNOLOGY
BOOTH NO.: A604



Fiber Optic Network Cabinet

JINBANG MACHINERY
TECHNOLOGY
BOOTH NO.: A503



144-core MPO High-density
Optical Fiber Junction Box

YAXUNEQUIPMENT
BOOTH NO.: A808-1



Optical Fiber Termin Box

JITONG ELECTRONICS
BOOTH NO.: A807



Fiber Distribution Box

KERUI COMMUNICATION
EQUIPMENT
BOOTH NO.: A808-21



86 Type Fiber Optic
Terminal box

GMF TELECOM
TECHNOLOGY
BOOTH NO.: A805



96F Closure

Cable Manufacturing Equipment

ELOIK COMMUNICATION
EQUIPMENT
BOOTH NO.: A611



IoT-enabled Fusion Splicer

ELOIK COMMUNICATION
EQUIPMENT
BOOTH NO.: A611



Hollow-core
Polarization-maintaining
Fiber Fusion Splicer

FIBERLINK COMMUNICATION
EQUIPMENT
BOOTH NO.: A808-8



Fully Automatic
Polarization-Maintaining
Fiber Fusion Splicer

SIGNAL FIRE
BOOTH NO.: A808-18



Fusion Splicer AI-9

TEKCN
BOOTH NO.: A114



Fiber Optic Fusion
Splicer

TENGYUE COMMUNICATION
EQUIPMENT
BOOTH NO.: A808-9



Fiber Optic Cutting
Machine

>>> [View More Products](#)



Featured Product Spotlight

Optical Component – Lens/Micro Lens/Metalens

*Exhibitors are listed in no order.

TECNOTTICA CONSONNI
BOOTH NO.: C205



Custom Spherical and
Aspherical Lenses

ARCHER OPTX
BOOTH NO.: B203



PerfectLens® Molded
Chalcogenide Aspheric Lens

NANO MACRO OPTICS
BOOTH NO.: C003



High Precision Optical
Lens

DXS OPTICS
BOOTH NO.: C331



Aspheric Lenses

LANTE OPTICS
BOOTH NO.: D231



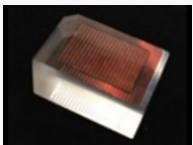
Precision Glass Molded
Aspheric Lens

TYGGO PHOTOELECTRICITY
BOOTH NO.: C112



Spherical Lens

AGC ASIA PACIFIC
BOOTH NO.: A334



Glass Molded
Microlens Array

METAOPTICS TECHNOLOGIES
BOOTH NO.: B611-A



Metalens 5G
Smartphone

SUNA
BOOTH NO.: A234



Microlens

ECOPTIK
BOOTH NO.: B234



Micro Lens

YINGZHIYI
BOOTH NO.: C134



Micro Lenses

TIANFU XINGLONG LAKE
LABORATORY
BOOTH NO.: C006



Wafer Level Metasurface

[>>> View More Products](#)



Featured Product Spotlight

Optical Component – Filter/Optical Design Software

*Exhibitors are listed in no order.

EDMUND OPTICS
SINGAPORE
BOOTH NO.: B303



Filter Optics

CHROMA TECHNOLOGY
BOOTH NO.: C207



Optical Filters For Medical
Instrumentation

ASPHERICON
BOOTH NO.: A224



Custom Optics

GIAI PHOTONICS
BOOTH NO.: C131



Optical Filter

YIZHAO PHOTONICS
TECHNOLOGY
BOOTH NO.: C223



Narrow Bandpass Filter

NANJING APEX OPTICS
BOOTH NO.: C233



Filters

Medical/AR&VR/Automotive Optics

IMT MASKEN UND
TEILUNGEN
BOOTH NO.: C202



LifeScience &
Diagnostics

LINGYINGCHUANG
OPTOELECTRONIC TECHNOLOGY
BOOTH NO.: C234



Medical Endoscope Lens

METAOPTICS TECHNOLOGIES
BOOTH NO.: B611-A



Metalens AI Glasses

HONGSHI
BOOTH NO.: D326



Aurora A6

FRAN OPTICS
BOOTH NO.: D223



High-precision HUD
Mirror

FRAN OPTICS
BOOTH NO.: D223



Lidar Optical Parts

[>>> View More Products](#)



Featured Product Spotlight

Camera Lens

*Exhibitors are listed in no order.

EDMUND OPTICS
SINGAPORE
BOOTH NO.: B303



Imaging Lenses

MITUTOYO ASIA PACIFIC
BOOTH NO.: A323



Objective Lens (UV to
Visible to IR)

HITRONICS TECHNOLOGIES
MALAYSIA
BOOTH NO.: B005, B006



Short-Wave Infrared (SWIR)
Fixed-Focus Lens

BOXIN PHOTOELECTRIC
BOOTH NO.: B232, B233



Lens Assembly

SILK OPTICAL
TECHNOLOGY
BOOTH NO.: D112



Dash Cam Lens

TRACE OPTICAL
BOOTH NO.: D026



TRC-F1007

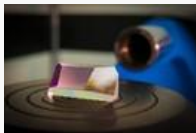
Optics Fabrication and Design Software

MOVEON
TECHNOLOGIES
BOOTH NO.: B332



Automotive Optics &
Component Fabrication

UAB ALTECHNA
BOOTH NO.: C214



Optics & Optical Designs

SMARACT GMBH
BOOTH NO.: A125



Optical Assembly
Solutions

TNO SCIENCE AND
INDUSTRY
BOOTH NO.: C204



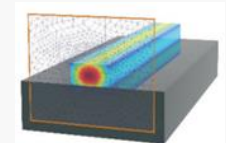
Design and Manufacturing
Of Optical (Sub)systems
and Components For
Space and Semicon

AOYI TECHNOLOGY
BOOTH NO.: B135



Optical Centering and
Assembly Service for
Lenses

ADVINNO TECHNOLOGIES
BOOTH NO.: B531



Zemax

[>>> View More Products](#)



Featured Product Spotlight

Optical Processing Equipment

OPTOTECH
OPTIKMASCHINEN
BOOTH NO.: A126



SM 80 CNC-TC

SATISLOH ASIA
BOOTH NO.: C213



SPM-10/SPS-10
Grinding & Polishing

GREENWICH
OPTOELECTRONIC TECHNOLOGY
BOOTH NO.: C104



Intelligent Robot
Polishing Equipment

AFISY TECHNOLOGIES
BOOTH NO.: D222



CCOS Polishing
Machine For Precision Optics

KINGDING
OPTICAL TECHNOLOGY
BOOTH NO.: D111



Freeform Surfaces (HUD)
Precision Molding
Machine MD12-180x120

BOHONGYUAN EQUIPMENT
BOOTH NO.: D101



DSP1500

*Exhibitors are listed in no order.

Optical Coating Equipment

EVATEC AG
BOOTH NO.: B502



CLUSTERLINE® Family

APP SYSTEMS SERVICES
BOOTH NO.: B331



Pfeiffer Vacuum HiCube
Neo Turbopumping
Stations

BUHLER ASIA
BOOTH NO.: C224



ALD 1200

HUICHENG
BOOTH NO.: D122, D123



Magnetron Sputtering
Optical Coating Equipment

KURT LESKER
BOOTH NO.: C126



PRO Line PVD 75

LBD TECHNOLOGY
BOOTH NO.: D104



Ion Beam Assisted
Coating Machine

[>>> View More Products](#)



Featured Product Spotlight

Optical Coating Equipment

*Exhibitors are listed in no order.

ULVAC
BOOTH NO.: C123



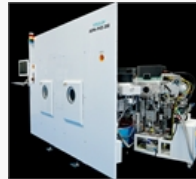
Evaporation Equipment

SISHENG TECHNOLOGY
BOOTH NO.: C116



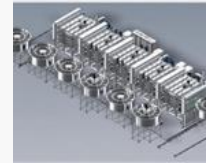
Magnetron Sputtering
Vacuum Coating Machine

YOULUN
BOOTH NO.: A511



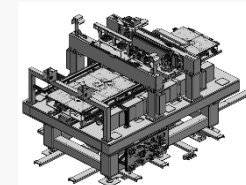
PVD 200

ELEMENT VACUUM TECHNOLOGY
BOOTH NO.: D321



Precision Optical Coater
(YS/LC3000/2000-3C)

CNS VISION TECHNOLOGY
BOOTH NO.: C115



Evaporation and Encapsulation
Defect Inspection Equipment (H-
Cut AOI)

YUANSU OPTOELECTRONICS
TECHNOLOGY
BOOTH NO.: D006



Large-Area ALD

Laser

ACEXON TECHNOLOGIES
BOOTH NO.: B311



Pharos - Solid State
Femtosecond Laser
System

CRYLAS GMBH
BOOTH NO.: A124



FQCW266-1200 - cw
Laser at 266 nm with 1.2
W Output Power

JD UNION
BOOTH NO.: B321



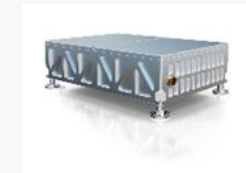
Lasers

STRONG LASER
BOOTH NO.: C330



500W IR Picosecond Laser

CRYSTRONG PHOTONICS
BOOTH NO.: D304



2.1-2.5µm Femtosecond
OPO Laser

DEVISER INSTRUMENTS
BOOTH NO.: A522



TLS1056 Hi-Performance
Tunable Laser Source

[>>> View More Products](#)



Featured Product Spotlight

Laser Component

*Exhibitors are listed in no order.

SCANLAB GMBH
BOOTH NO.: A121



IntelliSCAN IV Series

RAYLASE GMBH
BOOTH NO.: A123



SUPERSCAN IV

PICOLAS GMBH
BOOTH NO.: A134



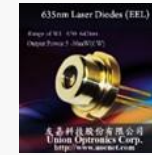
LDP-CW 20-50 Next Gen
- Laser Diode Driver

INXUN TECHNOLOGY
BOOTH NO.: C611



Wavelength-swept
Laser Series

UNION OPTRONICS
BOOTH NO.: D316



635nm Semiconductor
Laser Diodes

GYOPTICS TECHNOLOGY
BOOTH NO.: D501



1500W In-Line Isolator

Laser Equipment

HRLASER
BOOTH NO.: D311



HRLASER - A3MD30i -
Handheld Laser
Welding Machine

GWEIKE TECH
BOOTH NO.: D302



Thick Glass Cutting &
Splitting Machine GKS-
0606-GC

GWEIKE TECH
BOOTH NO.: D302



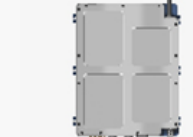
G2 20W Metal &
Plastic Fiber Laser
Engraver

CENTRAL RISE
BOOTH NO.: C534



N3D Laser Marking Kit

XK PHOTONICS
BOOTH NO.: D211



Small NA Blue Laser Module,
Multi-wavelengths Fiber
Output Module

JD UNION
BOOTH NO.: B321



Direct Machining Control:
DMC Software

[>>> View More Products](#)



Featured Product Spotlight

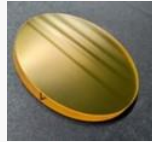
Infrared Optics and Lens

AIRBOARD TECHNOLOGY (S)
BOOTH NO.: B631



Imaging and Optical Solution

BLUE RESOURCE OPTICS
BOOTH NO.: C101, C102



Infrared Optical
Components

SD OPTICS SINGAPORE
BOOTH NO.: B324



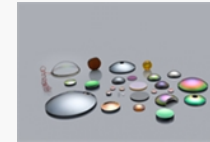
Infrared Optics

BOTE OPTICS
BOOTH NO.: B313



Infrared Components

VISION INFRARED
BOOTH NO.: C512



Components Made By
Chalcogenide Glasses

GIAI PHOTONICS
BOOTH NO.: C131



Infrared Non Spherical
Lens

**Exhibitors are listed in no order.*

Infrared Device

BOTE OPTICS
BOOTH NO.: B313



Custom Infrared Lens

WAVELENGTH
OPTO-ELECTRONIC (S)
BOOTH NO.: B514



Shortwave Infrared SWIR
Lenses

TIANFU
OPTOELECTRONIC TECHNOLOGY
BOOTH NO.: C604



Medium-wave Cooled
Catadioptric Zoom Lens

VITAL OPTICS
BOOTH NO.: C311



Cooled Infrared Modules

CORENT
BOOTH NO.: C312



FPV Thermal Imaging

ZHIRAN OPTOELECTRONICS
BOOTH NO.: B133



Infrared Objective Lens
System

[>>> View More Products](#)



Featured Product Spotlight

Infrared Device

BAITENG
ELECTRONIC TECHNOLOGY
BOOTH NO.: C502



UAV Hyperspectral
Camera System

BAITENG
ELECTRONIC TECHNOLOGY
BOOTH NO.: C502



Portable Hyperspectral
Camera

CHINA STATE
SHIPBUILDING HONGYANG
BOOTH NO.: C501



Infrared Thermal Imaging
Gas Leak detector

CHINA STATE SHIPBUILDING
HONGYANG
BOOTH NO.: C501



VOC Detection Payload

VITAL OPTICS
BOOTH NO.: C311



Thermal Cameras

SHIYUTONG TECHNOLOGY
BOOTH NO.: C315



Thermal Imaging
Telescope

*Exhibitors are listed in no order.

LiDAR and Sensing

LANHAI
PHOTOELECTRICITY
BOOTH NO.: C511



Laser Sensor

LANHAI
PHOTOELECTRICITY
BOOTH NO.: C511



Laser Sensor

ZHIXING SEMICONDUCTOR
BOOTH NO.: B115, B116



VCSEL Modules for 3D
Sensing

ZHIXING SEMICONDUCTOR
BOOTH NO.: B115, B116



VCSEL Chips For 3D
Sensing

CHENGYE HARDWARE
BOOTH NO.: D102



Temperature Sensor

SANSHENG ENCODER
BOOTH NO.: C333



SZM Ultra Thin Integrated
Magnetic Absolute Encoder

>>> [View More Products](#)



Featured Product Spotlight

Optical Test and Measurement

*Exhibitors are listed in no order.

NEXUSTEST
BOOTH NO.: B521



1.6T Benchtop Bit
Error Ratio Tester
PBT3058

ELOIK COMMUNICATION
EQUIPMENT
BOOTH NO.: A611



Access Network
Analyzer

KOREA ADVANCED
MATERIALS
BOOTH NO.: B102



Power Meter

TEKCN
BOOTH NO.: A114



Optical Time Domain
Reflectometer

DIMENSION
TECHNOLOGY
BOOTH NO.: A211, A212



1.6T/800G High-Speed
Signal Test Solution

SOLIWARE STORAGE
TECHNOLOGY
BOOTH NO.: A204



SWB-2000HX

DEVISER INSTRUMENTS
BOOTH NO.: A522



AE905 Multifunction
Modular Platform

SINGPHOTONICS
INTERNATIONAL
BOOTH NO.: A222



Ultra-High-Speed Bit
Pattern Generator (BPG)

JOIN-MU
INTELLIGENT TECHNOLOGY
BOOTH NO.: A502



MAP900-MBR MT-FA
Automatic Test System
(IL&RL&Polarity Detection)

HAITUO INSTRUMENT
BOOTH NO.: A313



3T BERT System

MICRO MOTION TECHNOLOGY
BOOTH NO.: D124



Digimatic Manual Stage
with Absolute Encoder

PUQING ELECTRONIC
TECHNOLOGY
BOOTH NO.: A002



100G, 200Gbps Clock
Recovery Unit

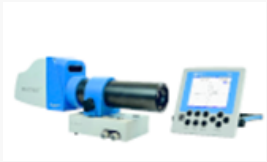
[>>> View More Products](#)



Featured Product Spotlight

Test and Measurement - Semiconductor

MÖLLER-WEDEL OPTICAL
BOOTH NO.: A133



ELCOMAT® 5000

IN-CUBE AUTOMATION
BOOTH NO.: B111



MS-WTW Wafer
Inspection and Sorting Machine

IN-CUBE AUTOMATION
BOOTH NO.: B111



Fully Automatic 4-Side
Optical Inspection
Equipment for Chips

THAHOO PHOTOELECTRIC
TECHNOLOGY
BOOTH NO.: B106



Chip Series Tester
(DFB/EML/High Power)

SHUHE TAI
TECHNOLOGY
BOOTH NO.: D029



NAND Flash Intelligent
Test System

LASER X TECHNOLOGY
BOOTH NO.: A808-17



COC Test&Burn-in
Equipment COC

**Exhibitors are listed in no order.*

Test and Measurement - Alignment Equipment

OPTOSIGMA
SOUTHEAST ASIA
BOOTH NO.: B301



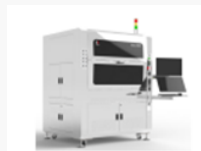
Optical Alignment
Systems

MRSI AUTOMATION
BOOTH NO.: B214



MRSI-A-L Active Aligner

AIT PRECISION
BOOTH NO.: A113



Dual-station Fully Automatic
Active Alignment Equipment

SMARACT GMBH
BOOTH NO.: A125



Fast Photonics
Alignment

AI PO LI INDUSTRIAL
BOOTH NO.: D005



CNC Scriber Version
C.C.D. Auto Alignment

BRIGHTAS
COMMUNICATION EQUIPMENT
BOOTH NO.: A112



800G Dual-FA
Automated Alignment Station

[>>> View More Products](#)



Featured Product Spotlight

Test and Measurement - Spectroscopy

AIRBOARD TECHNOLOGY (S)
BOOTH NO.: B631



Test and Measurement

HAKUTO SINGAPORE
BOOTH NO.: B513



OtO Photonics

AVENIR PHOTONICS
BOOTH NO.: A122



ARIS Spectrometer

CHENGDU INTERNATIONAL
TRADE GROUP
BOOTH NO.: C121



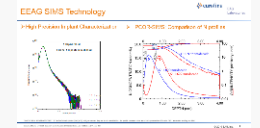
Fiber Optic
Spectrometers

GIE OPTICS
BOOTH NO.: D315



SEM-3000
Multifunctional Spectrum
Measurement System

AIWENSI
BOOTH NO.: A633



SIMS and Material
Surface Analysis

*Exhibitors are listed in no order.

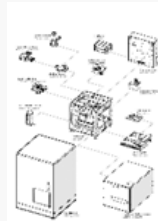
Test and Measurement - Microscope

MITUTOYO ASIA PACIFIC
BOOTH NO.: A323



VMU (Video
Microscope Units)

MÄRZHÄUSER WETZLAR
BOOTH NO.: C201



ScanExpress

OPTICAL GAGING (S)
BOOTH NO.: B333



OGP SmartScope M Series

DSC INDUSTRIAL
BOOTH NO.: B522



3D Instant Scanning
Ultra High-Precision Video
Measurement System (μm & nm)

Panasonic Factory
Solutions Asia Pacific
BOOTH NO.: A331



UA3P

LEJ - LEISTUNGSELEKTRONIK
JENA
BOOTH NO.: C203



LUXYR LED MAGNA

>>> [View More Products](#)



Featured Product Spotlight

Test and Measurement - Imaging Measurement/AOI

*Exhibitors are listed in no order.

AMETEK SINGAPORE
BOOTH NO.: B213



LUPHOScan 260 HD

TRIOPTICS SINGAPORE
BOOTH NO.: B304



Image Quality
(ImageMaster® HR 2)

INSTRUMENT SYSTEMS
BOOTH NO.: A127



LumiTop X30 AR – Spectrally
Enhanced Imaging Colorimeter
for AR Display Testing

ULTRA PRECISION
INTELLIGENT TECHNOLOGY
BOOTH NO.: A534



Wafer Surface Defect
Inspection Equipment
(AOI-W500)

TIMEMAKER CRYSTAL
TECHNOLOGY
BOOTH NO.: A203



Automated Optical
Inspection

THAHOO PHOTOELECTRIC
TECHNOLOGY
BOOTH NO.: B106



AOI Detection Machine

Test and Measurement - Positioning System

AIRBOARD
TECHNOLOGY (S)
BOOTH NO.: B631



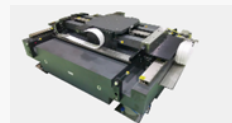
Precision Motion
Control

AKRIBIS SYSTEMS
BOOTH NO.: A513, A512



Miniature Stages -AM
Series

SHANNENG
PRECISION MACHNIERY
BOOTH NO.: D331



Precision XY Positioning
Stage

KAIFULL ELECTRONIC
TECHNOLOGY
BOOTH NO.: D303



Micro stage: YK-HL6020G-
SGN-5-815

COREMORROW
BOOTH NO.: C002



Piezo Nanopositioning
Stages

DIACION
BOOTH NO.: D204



UVW Positioning Platform

[>>> View More Products](#)



Conference Agenda At A Glance

Date	Time	Venue - Conference Room	Time	Venue - Technical Theatre
4 February 2026	10:00-12:00	2026 Asia Photonics Expo Opening Ceremony & Asia Photonics Conference Plenary Speech	11:00-12:10	2026 APE "Dongguan Products" Promotion Event
	13:30-17:00	Asia Semiconductor Conference 2026 - Singapore Semiconductor Industry Association (SSIA)	13:30-17:30	Quantum Singapore 2026
5 February 2026	9:00-17:00	Photonics@SG 2026 - LUX Photonics Consortium	10:30-12:30	Advanced Semiconductor Manufacturing Forum
			13:00-14:30	EPIC TechWatch: Photonics Applications Across Life Sciences, Medical, Semiconductor, and Communications
			15:00-17:00	2026 EUROPE meets ASIA - Innovation in Photonics by W3+ Fair, IVAM & EPIC
6 February 2026	10:30-17:00	Asia Photonics Conference	10:30-12:35	Machine Vision Enabling Industrial Intelligent Manufacturing Forum

[>>>View Full Conference Agenda](#)



Concurrent Conferences

2026 Asia Photonics Expo Opening Ceremony & Asia Photonics Conference Plenary Speech

Time: 04 February 2026 Venue: Conference Room

Time	Agenda
9:30-10:05	Registration
10:05-10:15	Welcome Address by Sukumar Verma Managing Director, Informa Markets, Singapore
10:15-10:30	APE Official Launch
10:30-10:35	MOU Signing
10:35-10:55	Industry Keynote: Dr. Patrick Lo Guo-Qiang, Senior Fellow, Technology Development, GlobalFoundries (former Chief Technology Officer, Advanced Micro Foundry, a part of GlobalFoundries) Speech Title: Integrated Photonics: Singapore's Next Engine of Semiconductor Innovation
10:55	End of Opening Ceremony
10:55-11:00	Asia Photonics Conference Welcome Address
11:00-11:35	Asia Photonics Conference - Plenary Speech 1 Chik-Patrick-YUE, The Hong Kong University of Science and Technology, China Speech Title: Optical PCIe/CXL Interconnect for Remote GPU, Accelerator, and Memory Expansion
11:35-12:10	Asia Photonics Conference - Plenary Speech 2 Goki Eda, National University of Singapore, Singapore Speech Title: Harvesting Excitons in Flatlands for Quantum Photonics
12:10	END

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Concurrent Conferences

Quantum Singapore 2026



Time: 04 February 2026 Venue: Technical Theatre

As a cornerstone of Singapore's "Quantum 2026" strategy, Quantum Singapore 2026 has established itself as one of the largest and most professional international exchange platforms for quantum technology in the Asia-Pacific region. Centered on the theme "Technology Implementation Ecosystem Symbiosis", it integrates "forum dialogues + technology exhibitions + ecosystem matchmaking" into a cohesive experience—serving as a pivotal window for the global quantum industry to glimpse the future of quantum technology.

Time	Topics	Speakers
14:00-14:10	Welcome & Opening Remarks	Shangjie Guo President, FinQ Tech Inc Quantum Computing Specialist, BP p.l.c.
14:10-14:30	Toward Neutral Atom Array Quantum Processors in Singapore	David Wilkowski, Principal Investigator, Centre for Quantum Technologies. Associate Professor, School of Physical & Mathematical Sciences – Division of Physics & Applied Physics, Nanyang Technological University
14:30-14:50	Quantum in the Photonic Datacenter	Peter Fretty, Vice President of Digital Infrastructure, EndeavorB2B
14:50-15:10	Quantum Communication: Securing Future Data Transmissions	Zhiding Liang, Assistant Professor at the CUHK CSE
15:10-15:30	Exploring the Utilization of Fault-Tolerant Quantum Computers by Using Classical Computers Cooperatively	Shigeru Yamashita, Professor, Ph.D.College of Information Science and Engineering,Ritsumeikan University
15:30-15:50	Dependable Quantum-Classical Systems Engineering - A holistic approach	Edo Giusto, Assistant Professor with the Department of Electrical Engineering and Information Technology at the University of Naples Federico II, Italy
15:50-16:40	Panel Discussion • How to address the "compatibility barrier" between quantum hardware and software? • How can the Southeast Asian quantum ecosystem build global differentiated competitiveness?	• Shangjie Guo • David Wilkowski • Peter Fretty • Zhiding Liang • Shigeru Yamashita • Edo Giusto
16:40-17:00	Closing Remarks & Networking	

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Concurrent Conferences

Photonics@SG 2026 - LUX Photonics Consortium



Time: 05 February 2026 Venue: Conference Room

Join us for the Photonics@SG 2026 Conference on 5 February 2026 at the APE Conference Room, organised by LUX Photonics Consortium themed "Next Horizon in Integrated Photonics." This full-day conference will feature an exciting lineup of international and local speakers, networking breaks, and a panel discussion with leading figures from academia and industry.

*Conference programme is subject to change. <[Click here](#) for the latest updates.>

Time	Topics	Speakers
8:45-9:30	Registration & Networking Breakfast	
9:30-9:40	Welcome Address by Conference Chair, Prof Chuan Seng Tan	
Session 1: Pioneering the Next Horizon Innovation Frontiers in Integrated Photonics Moderator: Prof Chuan Seng Tan/Prof Brian Sia		
9:40-10:10	Photonic-Electronic Co-packaging and Addressing Production Scale-up Challenges through Design Standardisation and Pilot Lines	Prof Peter O'Brien, Head of the Photonics Packaging & Systems Integration Group, Tyndall National Institute, University College Cork, Ireland
10:10-10:40	2D hBN for GaN Technologies: Scalable Epitaxy, Micro-LEDs, and Deep-UV Advances	Prof Abdallah Ougazzaden, President of Georgia Tech-Europe, Professor, Georgia Institute of Technology
10:40-11:10	Optical Metasurfaces for Imaging, Sensing, and Display	Prof Junsuk Rho, Yeon-San (延山) Endowed Chair Professor, Mu-Eun-Jae (无垠斋) Endowed Chair Professor, Pohang University of Science and Technology (POSTECH)
11:10-11:40	Flat Optics Technologies	Dr Arseniy Kuznetsov, Vice President, National Semiconductor Translation and Innovation Center (NSTIC)
11:40-12:40	Lunch	
Session 2: Pushing the Boundaries: New Material Platforms for Next-Generation Photonic Integrated Circuits Moderator: Prof Sanghoon Chae		
12:40-13:10	Device Performance of BEOL Ge Epitaxy on Si Devices	Dr Jurgen Michel, Senior Research Scientist, Massachusetts Institute of Technology
13:10-13:40	On-chip SNSPDs for Quantum Photonics and Single-photon Imaging	Prof Cesare Soci, Professor of Photonics, Nanyang Technological University Singapore
13:40-14:10	Electrically-pumped Topological Photonic Crystals Lasers	Prof Qijie Wang, President Chair Professor, Nanyang Technological University Singapore
14:10-14:40	Tea Break	



Concurrent Conferences

Photonics@SG 2026 - LUX Photonics Consortium



Time: 05 February 2026 Venue: Conference Room

Join us for the Photonics@SG 2026 Conference on 5 February 2026 at the APE Conference Room, organised by LUX Photonics Consortium themed "Next Horizon in Integrated Photonics." This full-day conference will feature an exciting lineup of international and local speakers, networking breaks, and a panel discussion with leading figures from academia and industry.

Time	Topics	Speakers
Session 3: Advancing High-speed, Low-power Silicon Photonics for Next-generation Chips and Architectures Moderator: Dr Satrio Wicaksono		
14:40-15:10	TBC	Prof Chengkuo Lee
15:10-15:40	Silicon Photonics Heterogeneous Integration (Si-PHI) - Augmenting Performance through Multi-Material Integration	Dr Xianshu Luo, Principal Scientist, Institute of Microelectronics, A*STAR
15:40-16:10	Chip-Scale Unification of the Terahertz and the Megahertz	Prof Brian Sia Jia Xu, Assistant Professor, Nanyang Technological University Singapore
16:10-16:20	Bio Break	
Session 4: Integration, Innovation, and Impact: The Evolving Landscape of Integrated Photonics Moderator: Prof Chuan Seng Tan		
16:20-17:20	Panel Discussion	Prof Peter O'Brien, Dr Jurgen Michel, Dr Mian Zheng(Hyperlight),
17:20-17:30	Closing Remark	Prof Chuan Seng Tan
17:30	End of Conference	
17:30-18:15	Post Conference Cocktail	
18:15	End of Cocktail	

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Concurrent Conferences

Asia Semiconductor Conference 2026 - Singapore Semiconductor Industry Association (SSIA)



Time: 04 February 2026 Venue: Conference Room

Organised by the Singapore Semiconductor Industry Association (SSIA), the Asia Semiconductor Conference brings together industry leaders, MNCs, and SMEs from across the region. This year's conference delves into integrated photonics (PICs), with a focus on scaling, advanced packaging, and system-level integration of photonic integrated circuits.

Time	Topics	Speakers
13:30-13:40	Opening Remarks	Ang Wee Seng, Executive Director, Singapore Semiconductor Industry Association
13:40-14:00	Co-Packaged Optics as the Next-Generation Packaging Solution	Dr Radha Nagarajan, Chief Technology Officer, Marvell
14:00-14:20	Innovations in the Semiconductor to Meet AI Demand	
14:20-14:40	PIC Applications	STMicroelectronics
14:40-15:00	Unlocking the Power of Light: Scaling User-Centric Photonics Innovation with Precision	Andri Mahendra, Founder, Nicslab
15:00-15:20	Unlocking the Next Generation of PICs and Co-Packaged Optics with Multiphysics EDA	Desmond Tan, Principal Application Engineer, Ansys (part of Synopsys)
15:20-16:00	Building the Silicon Photonics Supply Chain of the Future: Perspectives from Singapore and Global Partners	Chee Teck Lee, CEO and Co-Founder, Moveon Technologies Alex Wu, Vice Chairman, Heterogeneously Integrated Silicon Photonics Alliance (HiSPA)
16:00-17:00	Networking	
17:00	End of Conference	

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Concurrent Conferences

2026 EUROPE meets ASIA - Innovation in Photonics by W3+ Fair, IVAM & EPIC



Time: 05 February 2026 Venue: Technical Theatre

This forum is organised by renowned European organisations W3+, IVAM & EPIC, is set to be a remarkable event that brings together leading enterprises from the European optoelectronics industry to share their latest technological advancements and achievements. It could be a perfect chance to get in touch with key decision makers and potential collaborators across the industries.

Time	Presentation	Speakers
15:00-15:10	Opening EUROPE meets ASIA - Innovation in Photonics by W3+ Fair, IVAM & EPIC	Carlos Lee EPIC - European Photonics Industry Consortium, Paris, FR Orkide Karasu IVAM Microtechnology Network, Dortmund, DE
15:10-15:25	Multiple Signal Management on Glass	Mike Bade IMT microtechnologies AG, Greifensee, CH
15:25-15:40	Optics Heal the World	Dr. Georg Draude Chroma Technology GmbH, Olching, DE
15:40-15:55	3D Quartz Glass Devices with Integrated Fiber Handling Solutions for Fluidic and Gas Applications	Sebastian Büsche lambda glass solutions, Burgwedel, DE
15:55-16:10	TNO High-Tech Innovation with Impact: Optics for Space & Semicon	M.H.J. (Merijn) Voets TNO, NL
16:10-16:25	Laser Lenses: Main Features and Production Steps	Dr. Francesca Brambilla Tecnottica Consonni Srl, Calco (Lc) , IT
16:25-16:40	Don't Call it Glass! - Crystalline Optical Materials	Dr. Gordon von der Gönna Hellma Materials GmbH, Jena DE
16:40-16:45	Closing EUROPE meets ASIA - Innovation in Photonics by W3+ Fair, IVAM & EPIC	Carlos Lee EPIC - European Photonics Industry Consortium, Paris, FR
16:45	End of Session	

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Concurrent Conferences

EPIC TechWatch: Photonics Applications Across Life Sciences, Medical, Semiconductor, and Communications



Time: 05 February 2026 Venue: Technical Theatre

Organised by the European Photonics Industry Consortium, this session will highlight the practical and industrial use of photonics technologies across several key sectors: life-science tools and medical photonics, semiconductor photonics, integrated photonics and flat optics, imaging systems and sensors, lasers and fiber optics, and data center/telecommunications optical components including silicon photonics.

Time	Topics	Speakers
	Session Chair: Carlos Lee, EPIC - European Photonics Industry Consortium	
13:00-13:06	Welcome	EPIC (Belgium)
13:06-13:13	Optical testing and metrology systems	TRIOPTICS (Germany)
13:13-13:20	Thin-film technologies & Vacuum coating systems	I-Photonics (Lithuania)
13:20-13:27	Photonics components, lasers, modulation systems	Exail (France)
13:27-13:34	High-Precision Optical Systems in Semiconductor Manufacturing	Wavelength Optoelectronics (Singapore)
13:34-13:41	Beyond Optics: Scalable System Manufacturing for Advanced Photonic Applications	Asphericon (Germany)
13:41-13:48	Thin film deposition platforms for photonics, semiconductors, optoelectronics, and advanced packaging	Evatec (Switzerland)
13:48-13:55	Engineered semiconductor substrates for electronics	Soitec (France)
13:55-14:02	Galvo scan heads, laser beam positioning	SCANLAB (Germany)
14:02-14:09	High-performance laser optics and assemblies	ALTECHNA (Lithuania)
14:09-14:16	Robust ultrafast femtosecond laser sources	Menhir Photonics (Switzerland)
14:16-14:23	Fiber Spectroscopy for Live Process-control in-line	Art Fiber Systems (Germany)
14:23-14:30	Laser diode drivers and controllers	PicoLAS (Germany)
14:30	End of Session	

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Concurrent Conferences

Asia Photonics Conference



Time: 06 February 2026 Venue: Conference Room

Co-hosted by APE, Nanyang Technological University (NTU) and IEEE Photonics Society, the Asia Photonics Conference (APC) emerges as a pioneering academic platform for global photonics innovation. Focused on the latest cutting-edge technological breakthroughs and research frontiers in photonics, this event serves as a dynamic hub, uniting leading academics, prominent research institutions, and industry innovators worldwide. It offers a high-caliber venue for in-depth exchanges, collaborative exploration, and knowledge sharing around the transformative topics that will shape the future trajectory of the photonics field.

Technical Tracks: T1. Laser Technology; T2. Optical Communication and Networks; T3. Nanophotonics; T4. Specialty Fiber and Applications; T5. Biophotonics; T6. Integrated Photonics; T7. Optical Sensing and Measurement; T8. Optoelectronic Devices and Applications

Plenary Speakers



Chik Patrick Yue
The Hong Kong
University
of Science and
Technology, China



Goki Eda
National University
of Singapore,
Singapore

Invited Speakers



Boris Mizaikoff
Ulm University



Cheng Zhang
Huazhong University
of Science and Technology



Christina Lim
The University of Melbourne



Elaine Wong
The University of Melbourne



Jingwen Ma
The University of Hong Kong



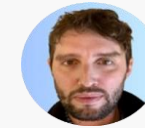
Jinyu Mo
POET Technologies



Longqing Cong
Southern University of
Science and Technology



Qihua Xiong
Tsinghua University



Robert Murray
Imperial College London



Renmin Ma
Peking University



Wei Li
Changchun Institute of Optics,
Fine Mechanics and Physics, CAS



Xiaoke Yi
University of Sydney



Yongquan Zeng
Wuhan University



Yu-Cheng Chen
Nanyang Technological University



Yuh-Renn Wu
National Taiwan University

*Conference programme is subject to change.
<[Click here](#) for the latest updates.>



Concurrent Conferences

Advanced Semiconductor Manufacturing Forum

Time: 05 February 2026 Venue: Technical Theatre

This forum will gather leading enterprises and experts from the semiconductor industry to share insights into market trends and technological advancements. It will delve into key topics such as cutting-edge semiconductor materials, equipment, and process technologies – inspiring collaboration and strengthening the foundation for a more resilient and future-ready semiconductor industry.

Time	Topics	Speakers
		Host: Joel K. W. Yang, Cheng Tsang Man Chair Professor Optica Fellow, Director (Cleanroom) Associate Head of Pillar (EPD) (Research and Advancement) Singapore University of Technology and Design (SUTD)
10:30-10:35	Opening and Welcome Speech	
10:35-10:55	Enabling Functional Diversity with Heterogeneous Integration	Chuan Seng Tan Professor, Nanyang Technological University, Singapore. Co-Director, National Centre for Advanced Integrated Photonics (NCAIP).
10:55-11:15	From Meta-Atoms to Mass Production: Scaling Metalens and Metasurface Optics for Imaging, Sensing and Semiconductor Manufacturing	Dr. Tobias W. W. Mass Vice President Systems, Metaoptics Technologies Pte Ltd.
11:15-11:35	Designing High-performance Co-Packaged Optics (CPO) with Photonic and Multiphysics Simulation	Albert Wong Technical Manager, Cybernet Systems Malaysia / Airboard Technology.
11:35-11:55	2.5D / 3D EDA+ New Paradigm - Advanced Packaging: Architecting & Physical Implementation, Simulation, and Testing	Dr. Alex Zhao Founder & CEO, Zhuhai Silicon Chip Technology Ltd.
11:55-12:15	Advanced FET and Photonic Technology Modeling Spanning Atomic Physics to IC Realization	Satish S Technical Manager, CADFEM SEA Pte Ltd.
12:15-12:35	Semiconductor Technological Innovation: Enabling the Future Vision of Smart Mobility and High-End Manufacturing	Dr. Rick MO Head, Business Development and Commercialisation, Head, Emerging Applications, Centre of Advanced Power and Autonomous Systems (APAS), Hong Kong Productivity Council (HKPC).

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Concurrent Conferences

Machine Vision Enabling Industrial Intelligent Manufacturing Forum

Time: 06 February 2026 Venue: Technical Theatre

The forum will gather leading enterprises and research institutes for in-depth exchanges and discussions on industry application needs and key technologies. This will focus on the industrial transformation on “Intelligent Manufacturing” that breakthrough the boundaries of traditional applications.

Time	Topics	Speakers
Host: Qian Kemao, Associate Professor, Nanyang Technological University.		
10:30-10:35	Opening and Welcome Speech	
10:35-10:55	Innovative Practices in Photonics Technology: LiDAR, Semiconductor Inspection and AI-Enabled Industrial Manufacturing	Yu Weiwen Senior Manager, Hong Kong Applied Science and Technology Research Institute (ASTRI)
10:55-11:15	LiDAR in Industry: Applications and Future Prospects	Bob Hu Senior Field Application Expert, Jinhua Lanhai Photoelectricity Technology Co., Ltd.
11:15-11:35	Coating Technologies for High-Throughput and High-Quality Deposition for Optical and Optoelectronic Applications	Dr. Kunz, Alexander Senior Technologist, Precision Optics. Bühler Group.
11:35-11:55	Measurement Research for Industry	Qian Kemao Associate Professor, Nanyang Technological University.
11:55-12:15	Tailoring Imaging Lenses to Maximize Performance and Minimize Cost	Lee Kok Xian Business Development Manager, Edmund Optics Singapore Pte Ltd.
12:15-12:35	Accelerating Vision System Design with Modular All-In-One Motion Control	Adlin Alwyn Applications Engineer, Zaber Technologies / Airboard Technology.

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Concurrent Conferences

Dongguan Excellence Showcase at APE 2026 **--- Featuring Premium Products & Innovations from Dongguan**

Time: 04 February 2026 Venue: Technical Theatre

To further expand the influence of "Made in Dongguan," help enterprises explore markets, encourage technological innovation and commercialization of research outcomes among Dongguan companies, and promote leapfrog development in related industries in Dongguan. During the expo, Electronics Information Industry Association of Dongguan will host this event to vigorously promote the "Guangdong Trade Global · Made in Dongguan" brand and assist enterprises in expanding their export markets.

Time	Topics	Speakers
11:00-11:05	Opening and Welcome Speech	
11:05-11:13	Measurement From Micro-Two-Dimensional to Macro-Three-Dimensional Dimensions	Shingo Global Marketing Manager, Dongguan Dingteng Instrument Co., Ltd
11:13-11:21	When Micro Stage "Meet" Linear Encoder- Defining a New Standard for Closed-Loop Accuracy	Daniel Ding Sales manager, Guangdong Kaifull Electronic Technology Co., Ltd
11:21-11:29	Lanjin - The Pioneer of Customized LED Solutions	Ava Huang Overseas sales manager, Dongguan Lanjin Optoelectronics Co., Ltd
11:29-11:37	Precision Intelligent Manufacturing, Powerful Empowerment — Special Promotion of Jinyuan Core Components	Minjin Li General Manager, Dongguan Jinyuan Hardware Machinery Co., Ltd
11:37-11:45	Brief Introduction of ShengFeng	Kaithy Chen Sales manager, Dong Guan ShengFeng Technology Co., Ltd
11:45-11:53	Development and Application of New Materials for Optical Coatings-Superhard and Superwear-resistant	Liming Fu General Manger, Dongguan Nafeng New Materials Co., Ltd
11:53-12:01	Boosting On-Chip Optical Interconnection Efficiency with Micro-Nano optical Devices	Ethan Lee Global Marketing Manager, VIKO(DONGGUAN)OPTICSTECHNICAL CO., LTD
12:01-12:09	Optical Coating Materials and Their Applications	Zhe liu General Manager, DONGGUAN KAIYONG PHOTO-ELETRONIC TECH. CO., LTD

*Conference programme is subject to change. <[Click here](#) for the latest updates.>



Networking Events

Site Tour One: JM VisTec and MMI Systems

Date: 4 February 2026 Time: 13:45 to 17:30

APE Site Tour offers a first-hand look into Singapore's leading photonics companies and research hubs. It is a powerful catalyst for connection, learning, and collaboration, driving the future of technology.

Time	Agenda	Venue
13:15-13:45	Gather at MBS, Level 1, Pick Up/ Drop Off Point	Level 1, Sands Expo and Convention Centre, Porte Cochere (Outside of Hall B)
13:45-14:15	Departure from MBS to JM VisTec	Level 1, Sands Expo and Convention Centre, Porte Cochere (Outside of Hall B)
14:15-14:35	Introduction	JM VisTec
14:35-14:45	Q&A	JM VisTec
14:45-15:30	Demonstration of Stations & Networking	JM VisTec
15:30-15:35	Head to MMI Systems	MMI Systems
15:35-17:05	MMI Systems Site Tour	MMI Systems
17:05-17:30	Arrival at MBS	Sands Expo & Convention Centre

*Agenda is subject to change. <[Click here](#) for the latest updates.>



Networking Events

Site Tour Two: LITEON and SUTD

Date: 4 February 2026 Time: 13:00 to 18:00

APE Site Tour offers a first-hand look into Singapore's leading photonics companies and research hubs. It is a powerful catalyst for connection, learning, and collaboration, driving the future of technology.

Time	Agenda	Venue
12:30-13:00	Gather at MBS, Level 1, Pick Up/ Drop Off Point	Level 1, Sands Expo and Convention Centre, Porte Cochere (Outside of Hall B)
13:00-13:30	Departure from MBS to LITEON	Level 1, Sands Expo and Convention Centre, Porte Cochere (Outside of Hall B)
13:30-13:45	Opening Speech and Introduction	LITEON
13:45-14:05	Showroom Tour	LITEON
14:05-14:25	Optoelectronic Product & Solution (OPS) TDD Lab	LITEON
14:25-14:45	Singapore Regional and Operation Lab (SGRO)	LITEON
14:45-14:55	Q&A and Closing Remarks	LITEON
14:55-15:00	Group-Photo	LITEON
15:00-15:20	Bus estimated to take 20minutes to reach SUTD	
15:20-15:50	Introduction of SUTD	SUTD
15:50-16:30	Campus Tour 1. Cleanroom, Metrology labs 2. Optical Quasar Lab 3. Campus tour	SUTD
16:30-17:30	Networking	SUTD
18:00	Arrival at MBS	Sands Expo & Convention Centre

*Agenda is subject to change. <[Click here](#) for the latest updates.>



Networking Events

Site Tour Three: NTU and A*STAR NSTIC

Date: 6 February 2026 Time: 9:30 to 13:00

APE Site Tour offers a first-hand look into Singapore's leading photonics companies and research hubs. It is a powerful catalyst for connection, learning, and collaboration, driving the future of technology.

Time	Agenda	Venue
9:00-9:30	Gather at MBS, Level 1, Pick Up/Drop Off Point	Level 1, Sands Expo and Convention Centre, Porte Cochere (Outside of Hall B)
9:30-10:00	Departure from MBS to NTU	Level 1, Sands Expo and Convention Centre, Porte Cochere (Outside of Hall B)
10:00-10:20	NTU: Introduction to National Centre for Advanced Integrated Photonics	NTU
10:20-11:00	Lab Tour: Split into 2 groups of 10pax, 20minutes per lab Group A: Centre for Disruptive Photonic Technologies (CDPT) Group B: TeraX Lab	NTU
11:00-11:30	Bus estimated to take 30minutes to reach A*STAR NSTIC	
11:40-11:45	A*STAR NSTIC Introduction of Synthesis Fab	A*STAR NSTIC
11:45-12:05	Tour of NSTIC GaN Center Level 1	A*STAR NSTIC
12:05-12:35	Window Tour of A*STAR Cleanroom Level 2	A*STAR NSTIC
12:35-12:45	Debrief and Group-Photo	A*STAR NSTIC
12:45-13:00	Bus estimated to take 15 minutes to reach MBS	Sands Expo and Convention Centre

*Agenda is subject to change. <[Click here](#) for the latest updates.>



Networking Events

Gala Dinner (By Invitation Only)

[>>>Register Your Interest](#)

An exclusive evening of elegance and inspiration. Network with top industry leaders in a sophisticated setting while enjoying gourmet cuisine and live entertainment. This is your chance to build lasting relationships in a relaxed yet impactful atmosphere.

Time: 4 February 2026 18:00-21:00 **Venue:** LAVO, Marina Bay Sands, Tower 1, Level 57



Happy Hour

[>>>Register Your Interest](#)

Unwind and connect in a casual, vibrant environment. Share ideas, exchange contacts, and foster new connections over refreshing drinks and light bites. Perfect for sparking conversations that lead to future collaboration.

Time: 5 February 2026 17:00-18:00 **Venue:** VIP Lounge **Attendee:** All VIP/Buyer & Exhibitor





Connect with Over 6,000 Industry Professionals at APE 2026

APE 2026 Featured Visitor Registration List (updated as of 7 Jan 2026)

- A*STAR
- ACE OPTICAL CO.
- ADVAL TECH HOLDINGS
- ADVANCED MICRO DEVICES
- ADVINNO TECHNOLOGIES
- AEM SINGAPORE
- AIBEL
- Amazon
- AMD SINGAPORE
- AMS OSRAM
- AMT
- ANRITSU
- APPASAMY ASSOCIATES
- APPLE
- APPLIED MATERIALS
- APPS-CONNECT
- ARROW ELECTRONICS
- ASML
- ASMPT SMT SINGAPORE
- AUMOVIO SINGAPORE
- AUTOMATED MICRON ASSEMBLY
- AXIS PRECISION
- BIOTRONIK APMII
- BOLTCHIP
- BRIDGES AUTOMATION
- BROADCOM
- C. STEINWEG ASIA
- COHERENT
- COMPOUNDTEK
- C-SKY SCIENTIFICS
- DELO
- DELTA ELECTRONICS
- DELTA OPTICS
- DKSH SINGAPORE
- DTDs TECHNOLOGIES
- EDMUND OPTICS
- EMERSON
- ENDRESS+HAUSER
- ENLIGHT TECHNOLOGY
- ENNOVI
- ETCHON
- EXCELITAS TECHNOLOGIES
- FOXCONN
- FRONKA TECH
- FUJIKURA FIBER OPTICS
- GIGADEVICE
- HAUSERU JAPAN
- HEIDENHAIN PACIFIC
- HEWLETT PACKARD
- HINDUSTAN OPTICALS
- HITEC
- HIWIN SINGAPORE
- HP SINGAPORE
- HUAWAI
- IBM SINGAPORE
- INFINEON TECHNOLOGIES
- ILEAD ICT SOLUTIONS
- ILLUMINOS TECHNOLOGY
- I-PHOTONICS UAB
- JABIL CIRCUIT
- JADE MICRON
- JM VISTEC
- KADDADLE
- KARKIM GROUP
- KEYSIGHT TECHNOLOGIES
- KIAST
- KLA INC.
- KUMPULAN ABEX
- LEICA INSTRUMENTS SINGAPORE
- LEUZE ELECTRONIC
- LINKSTAR MICROTRONICS
- LIGHTHAUS PHOTONICS
- LIGHTSPEED PHOTONICS
- LUMILEDS
- LUMINAR
- MARVELL TECHNOLOGIES
- MASSACHUSETTS INSTITUTE OF TECHNOLOGY
- MATTSON TECH
- METER-LAB
- METRAVI INSTRUMENTS
- MGI INSTRUMENTS
- MICRON
- MITSUBISHI
- MOLEX
- MSR TECHNOLOGY
- MURATA ELECTRONICS
- NEC APAC
- NEOLT ASIA
- OPTIKS MECHATRONICS
- PIXELLIGENT
- PEPPERL-FUCHS ASIA
- PHOTONIX AI
- QUALCOMM
- QUALIVON TECHNOLOGIES
- QUANTUMX
- REALTEK SEMICONDUCTOR
- SAMSUNG ELECTRONICS
- SCHNEIDER KREUZNACH
- SMC CORPORATION
- SOITEC MICROELECTRONICS
- SONY
- SSMC
- ST MICROELECTRONICS
- TESLA
- TEXAS INSTRUMENTS
- TNETS GLOBAL
- WAVELENGTH

and many more...



Delegation Registration

>>> [Download the delegation form](#)

It's designed for enterprises, associations, institutes, and colleges wishing to organise delegation groups of 3 or more people, including staff or members involved in R&D, production, processing, manufacturing, procurement, or supply chain, to visit APE.

Benefits of Delegation

- ✓ Free admission
- ✓ Free eCatalogue 2026
- ✓ Delegation Visiting Gift
- ✓ **Business Matchmaking Service** (upon request in advance)

>>> [Submit your sourcing request](#)

Note: Please complete the delegation form and send to Carrie Wu at Carrie.Wu@informa.com



VIP Buyer Programme

>>> [Register as a VIP Buyer](#)

The VIP Buyer Programme offers exclusive, tailored VIP services for key buyers and senior decision-makers in the photonics industry. This programme is designed for individuals with specific sourcing or purchasing needs, primarily targeting **top management, sourcing and supply chain professionals, R&D engineers**, and those in **production and manufacturing**.

APE provides verified buyers with a **FREE business matchmaking** service by arranging on-site meetings in the VIP lounge.

>>> [Submit your sourcing request](#)





Traffic Guide

Sands Expo and Convention Centre, Singapore

Address: 10 Bayfront Avenue, Singapore 018956

➤ Metro

Sands Expo and Convention Centre is located at Bayfront MRT station (CE1/DT16).

MRT services to/from Bayfront MRT station operate daily from approximately 6am to 12am midnight. The station connects to the Circle and Downtown Line of Singapore's Mass Rapid Transit (MRT) train system.

MRT Exits:

Exit C & D:

Sands Expo & Convention Centre (3-minute walk)

Exit E:

Sands Expo & Convention Centre

➤ Car & Taxi

Pick-Up/Drop-Off Points:

Outside Sands Expo & Convention Centre

➤ Car Park Entrance

Bayfront Link, next to Sands Expo & Convention Centre (South Entrance)



Hotel Reservation

For Hotel Reservation Only

Burnaby Solutions Pte Ltd (licensed travel agency with Singapore Tourism Board)

Service Hotline: +65 69110855

Email: enquiry@burnaby-solutions.com

For Hotel Reservations, visit:

https://register.burnaby-solutions.com/v2/booking/step1_all/445

For Tour Packages to APE

Shenzhen Synergy International Expo Services Co., Ltd.

Details on the available tour packages:

<https://www.asiaphotonicsexpo.com/wp-content/uploads/2025/08/APE2026-One-stop-Service.pdf>

Singapore Office

Xi ZhiGuo, xizhiguo.sg@gmail.com, +65 96219768

Shenzhen Office

Jolene Wang, Jolene.wang@hotmail.com, +86 13991921155

Cai, 673748668@qq.com, +86 18991359800



Product Brochure Download



← [Click here to download](#)

>>> [For more media downloads, visit the APE 2026 Download Center.](#)

APE

Asia
Photonics
Expo

4 - 6 February 2026

Sands Expo and Convention Centre, Singapore

Held in:



Brought to you by:



Supported by:



Contact us

- Visitor Enquiries: visitors-ape@informa.com

Click [here](#) to register for your free visitor pass.

- Exhibitor Enquiries: sale-ape@informa.com

Click [here](#) to submit a booth application.



REGISTER FOR
YOUR FREE PASS



JOIN APE'S WHATSAPP
COMMUNITY

www.asiaphotonicsexpo.com

#APE2026 [in](#) [f](#) [X](#) [v](#) [w](#)